

MDTE Series

Wire Wound Molded SMD Power Inductors

Size 6050



FEATURES

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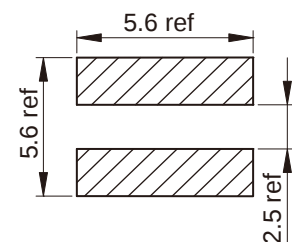
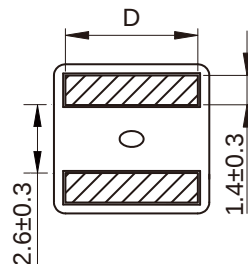
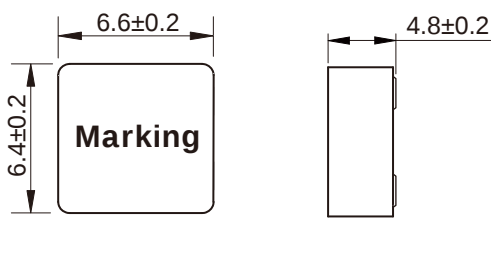
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APPLICATION

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Dimensions: [mm]

Land Pattern: [mm]



Electrical Properties:

Part No	Inductance @ 100KHz/0.1V	Tolerance	Current Typ.	Current Max.	Temperature Rise Current Typ.	DC Resistance Max.	D

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$

Soldering Reflow:

Preheat condition: 150 ~200℃ / 60~120 sec.

Allowed time above 217℃ : 60~90 sec.

Max temperature: 260℃.

Max time at max temperature: 10 sec.

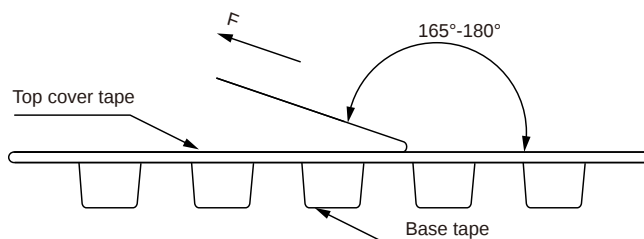
Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE6050	7.0 ± 0.1	6.8 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	12.0 ± 0.1	16.0 ± 0.3	5.3 ± 0.1	1.75 ± 0.1	0.35 ± 0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Reel Dimension: [mm]



Packaging Quantity: